

- ★ Super Low Gate Charge
- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

## **Description**

The XR100N20H is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The XR100N20H meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

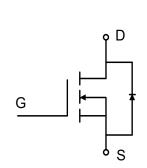
## **Product Summary**



BVDSS	RDSON	ID
200V	20 mΩ	100A

### **TO247 Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	200	V	
V <sub>G</sub> s	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1,6</sup>	100	Α	
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1,6</sup>	63	Α	
Ірм	Pulsed Drain Current <sup>2</sup>	400	Α	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	1190	mJ	
las	Avalanche Current		Α	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	272	W	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>0JA</sub>	Thermal Resistance Junction-Ambient <sup>1</sup>			°C/W
Rejc	Thermal Resistance Junction-Case <sup>1</sup>		0.46	°C/W



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	200			V
⊿BV <sub>DSS</sub> /⊿T <sub>J</sub>	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA				V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10 V, I <sub>D</sub> =61A		20	25.5	mΩ
1-20(014)		$V_{GS}$ =4.5 $V$ , $I_D$ =61 $A$				
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> . I <sub>D</sub> =250uA	3		5	V
$\Delta V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	100 100, 10 200				mV/°C
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =150V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA
IDSS	Drain-Source Leakage Guiterit	$V_{DS}$ =150V, $V_{GS}$ =0V , $T_J$ =100 $^{\circ}$ C			100	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	$V_{DS}$ =10V , $I_{D}$ =31A		73		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.2		Ω
$Q_g$	Total Gate Charge			134		
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =50V , V <sub>GS</sub> =10V , I <sub>D</sub> =61A		49.6		nC
$Q_{gd}$	Gate-Drain Charge			39.6		
T <sub>d(on)</sub>	Turn-On Delay Time			36.3		
Tr	Rise Time	$V_{DD} = 50V, R_L = 1.25\Omega$		9.2		
$T_{d(off)}$	Turn-Off Delay Time	$R_G = 3\Omega$ , $V_{GS}=10V$		64		ns
T <sub>f</sub>	Fall Time			6.3		
C <sub>iss</sub>	Input Capacitance			8826		
Coss	Output Capacitance	V <sub>DS</sub> =50V , V <sub>GS</sub> =0V , f=1MHz		532		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			148		

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			65	Α
VsD	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =31A , T <sub>J</sub> =250			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	IF=61A ,di/dt=100A/μs ,		102		nS
Qrr	Reverse Recovery Charge	T <sub>J</sub> = 25 C		550.3		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature. Notes 2.E<sub>AS</sub> condition:  $T_J$ =25 °C, $V_{DD}$ =40V, $V_G$ =10V, Rg=25 $\Omega$ , L=0.5mH.

Notes 3. Repetitive Rating: Pulse width limited by maximum junction temperature.



# **Typical Electrical And Thermal Characteristics (Curves)**

**Figure 1. Output Characteristics** 

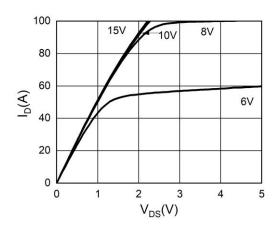


Figure 2. Transfer Characteristics

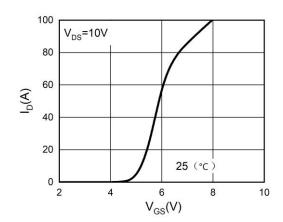


Figure 3. Power Dissipation

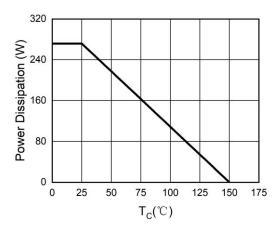


Figure 4. Drain Current

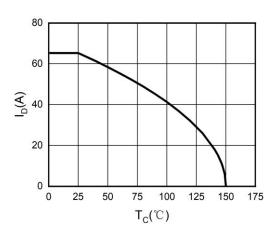


Figure 5. BV<sub>DSS</sub> vs Junction Temperature

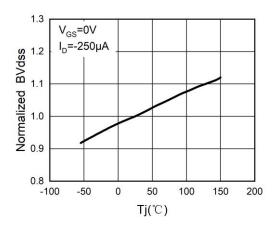
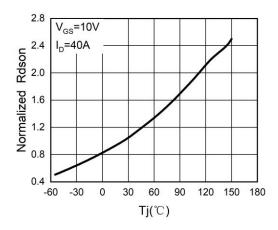


Figure 6. R<sub>DS(ON)</sub> vs Junction Temperature





# **Typical Electrical And Thermal Characteristics (Curves)**

Figure 7. Gate Charge Waveforms

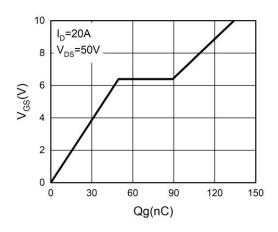


Figure 8. Capacitance

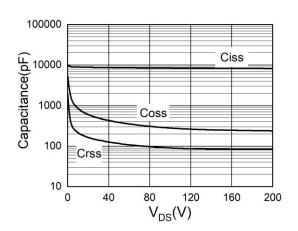


Figure 9. Body-Diode Characteristics

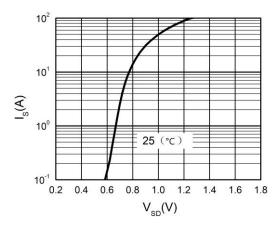
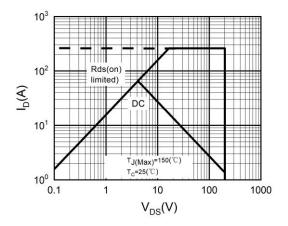
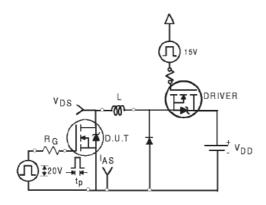


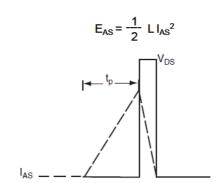
Figure 10. Maximum Safe Operating Area



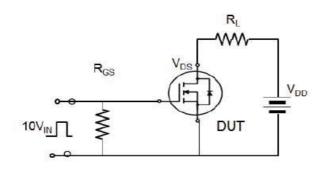


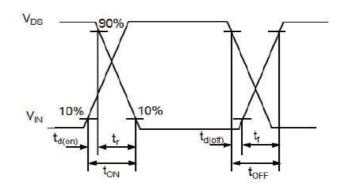
# **Avalanche Test Circuit**



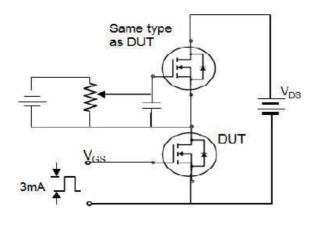


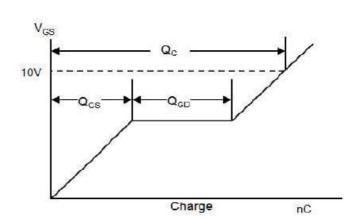
# **Switching Time Test Circuit**





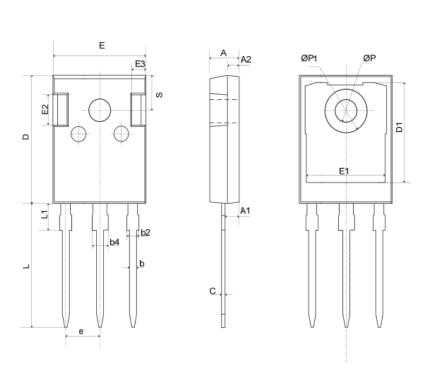
# **Gate Charge Test Circuit**







## **Mechanical Dimensions for TO-247**



### **COMMON DIMENSIONS**

	MM		
SYMBOL	MIN	MAX	
Α	4.80	5.20	
A1	2.21	2.61	
A2	1.85	2.15	
b	1.11	1.36	
b2	1.91	2.21	
b4	2.91	3.21	
С	0.51	0.75	
D	20.70	21.30	
D1	16.25	16.85	
E	15.50	16.10	
E1	13.00	13.60	
E2	4.80	5.20	
E3	2.30	2.70	
е	5.44BSC		
L	19.62	20.22	
L1	I	4.30	
ØΡ	3.40	3.80	
ØP1	_	7.30	
S	6.15BSC		